

In re Application of:  
Li, et al.

**Serial No.: 10/801,190**

Confirmation No.: 1633

Filed: March 15, 2004

For: Adhesion Improvement for Low K Dielectrics



Group Art Unit: 2891

Examiner: Granvill D. Lee

**MAIL STOP AMENDMENT**  
**Commissioner for Patents**  
**P.O. Box 1450**  
**Alexandria, VA 22313-1450**

Dear Sir:

**CERTIFICATE OF MAILING**  
**37 CFR 1.8**

I hereby certify that this correspondence is being deposited on August 30, 2005 with the United States Postal Service as First Class Mail in an envelope addressed to: Mail Stop Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

August 30, 2005  
Date

**Brian K. Hrna**

**RESPONSE TO OFFICE ACTION DATED JUNE 3, 2005**

In response to the Office Action dated June 3, 2005, having a shortened statutory period for response set to expire on September 3, 2005, please enter this response and reconsider the claims pending in the application for reasons discussed below. Although Applicant believes that no additional fees are due in connection with this response, the Commissioner is hereby authorized to charge counsel's Deposit Account No. 20-0782/APPM/008670/BKH, for any fees, including extension of time fees or excess claim fees, required to make this response timely and acceptable to the Office.

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper. **Remarks** begin on page 7 of this paper.